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TDA18275

Hybrid (analog and digital) silicon tuner for terrestrial and cable TV reception

Rev. 2 — 14 October 2013

Product short data sheet

1. General description

The TDA18275 is a high performance silicon tuner designed for terrestrial and cable TV reception for both analog and digital broadcasts.

The TDA18275 supports all analog and digital TV standards and delivers a Low IF (LIF) signal to a demodulator for analog TV and/or a channel demodulator for digital TV.

The TDA18275 facilitates TV design by:

- · Allowing on-board integration
- · Drastically reducing the tuner Bill Of Material (BOM)
- · Providing flexibility in system solution development

2. Features and benefits

- Single 3.3 V supply voltage
- Worldwide multistandard terrestrial and cable capabilities
- Alignment free
- RoHS compliant
- I²C-bus interface compatible with 3.3 V microcontrollers
- Fully integrated oscillators
- Fully integrated RF selectivity (no need for RF tracking filters coils)
- 2 programmable General-Purpose Outputs (GPO)
- Dual IF output ports
- 1.7 MHz, 6 MHz, 7 MHz, 8 MHz and 10 MHz channel bandwidths
- LIF channel center frequency output ranging from 0.8 MHz to 7.5 MHz
- Fully integrated IF selectivity; eliminating the need for external SAW filters
- Large flexibility in the IF filtering stage to ease the matching with various demodulators circuits
- Single-ended RF input, no need for external balun
- Excellent return loss compatible with cable requirements
- Power Level Detector (PLD) embedded
- Integrated gain control
- Self-AGC synchronization mode (VSync) for analog reception
- Very fast tuning time
- Strong immunity to LTE interferers in the digital dividend bandwidth
- Strong immunity to WLAN interferers (802.11 a/b/g/n)



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3. Quick reference data

Table 1. Quick reference data

Table 1.	Galox Telefolioe data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f_{RF}	RF frequency	full range of RF input	42	-	1002	MHz
NF _{tun}	tuner noise figure	75 Ω impedance source; maximum gain; RF < 870 MHz	-	3.3	3.8	dB
		75 Ω impedance source; maximum gain; 870 MHz \leq RF \leq 1002 MHz	-	3.9	4.5	dB
Φjit	phase jitter	integrated from 250 Hz to 4 MHz	-	0.4	0.6	degree
α_{image}	image rejection	worst case, measured at 4 MHz IF frequency and for image levels above $60~dB\mu V$	-	65	-	dB
CSO	composite second-order distortion	worst interferer over RF frequency with respect to wanted carrier	[1] -	-70	-65	dBc
CTB	composite triple beat		-	-70	-65	dBc
ICP _{1dB}	1 dB input compression point	at the tuner input and minimum gain	120	-	-	dBμV

^[1] Test scenario: standard NTSC M/N.

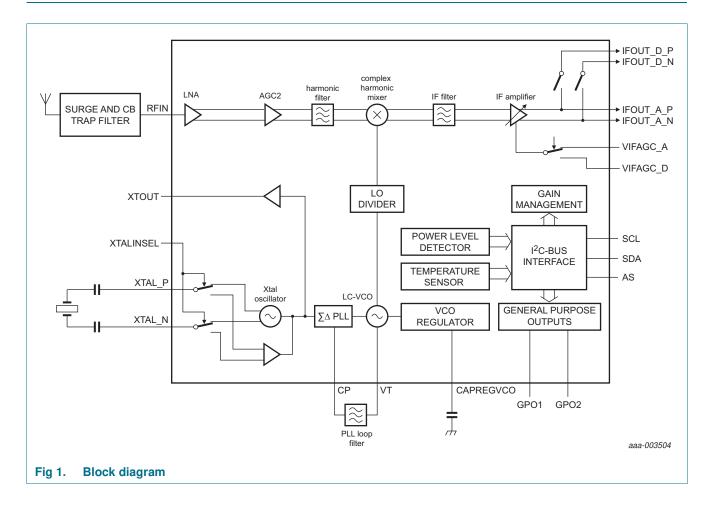
4. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
TDA18275HN/C1	HVQFN32	plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body $5\times5\times0.85$ mm	SOT617-11	

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5. Block diagram



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6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.3	+3.6	V
V _I input voltage	input voltage	V _{CC} < 3.3 V	-0.3	$V_{CC} + 0.3$	V
		V _{CC} > 3.3 V	-0.3	+3.6	V
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-20	<u>[1]</u>	°C
V _{ESD} electrostatic discharge	electrostatic discharge voltage	EIA/JESD22-A114 (HBM)	-2	+2	kV
		EIA/JESD22-C101-C (FCDM) class III2	1000	-	V
GPO pin	GPO pins: GPO1 and GPO2				
V_{CC}	supply voltage	0 V < V_{pu} < 5.5 V; R_{pu} > 390 Ω	-0.3	+5.5	V
I _{CC}	supply current	corresponding GPO ON	-20	0	mA
V_{ESD}	electrostatic discharge voltage	EIA/JESD22-A114 (HBM)	-650	+650	V
		EIA/JESD22-C101-C (FCDM) class IV[2]	1000	-	V

^[1] The maximum allowed ambient temperature $T_{amb(max)}$ depends on the assembly conditions of the package and especially on the design of the Printed-Circuit Board (PCB) and die connection. The application mounting must be done in such a way that the maximum junction temperature is never exceeded. The junction temperature can be obtained by reading the temperature sensor bit via I^2C -bus. The junction temperature: $T_j = T_{amb} + \Delta T_{j-c}$. where $\Delta T_{j-c} = power \times R_{th}$.

^[2] Class IV: ≥ 1000 V.

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7. Abbreviations

Table 4. Abbreviations

Table 4.	Appreviati	Olis
Acronym		Description
AGC		Automatic Gain Control
AS		Address Selection
BOM		Bill Of Material
СВ		Citizen Band
ESD		ElectroStatic Discharge
FCDM		Field-induced Charged-Device Model
GPO		General Purpose Outputs
HBM		Human Body Model
IF		Intermediate Frequency
LC-VCO		Inductors and Capacitors - Voltage Controlled Oscillator
LIF		Low IF
LNA		Low-Noise Amplifier
LO		Local Oscillator
LTE		Long-Term Evolution
NF		Noise Figure
NTSC		National Television System Committee
PCB		Printed-Circuit Board
PLD		Power Level Detector
PLL		Phase-Locked Loop
RF		Radio Frequency
RoHS		Restriction of Hazardous Substances
SAW		Surface Acoustic Wave
VCO		Voltage Controlled Oscillator
VSync		Vertical Synchronization
Xtal		Crystal
WLAN		Wireless Local Area Network

8. Revision history

Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TDA18275_SDS v.2	20131014	Product short data sheet	-	TDA18275_SDS v.1
Modifications:	• <u>Table 1</u> : upo	dated.		
TDA18275_SDS v.1	20130710	Preliminary short data sheet	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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